

# **Microsemi Corporation**

October 16, 2017

Product/Process Change Notification No: PPS110A060B14

Change Classification: Major

**Subject:** Moving wafer fab from Bend 4" to foundry 6"

**Description of Change:** Chips for these products are currently built in the Bend 4" wafer fab. Over the next 12 months these chips will be transferred to a 6" foundry. The Microsemi proprietary process will be transferred with as little change as possible to the process flow while fitting into the foundry's process flow and equipment capabilities.

**Reason for Change:** Bend wafer fab will be closing over the next 24 months.

## **Application Impact:**

No changes to the datasheets of these products are expected with this transfer.

# **Method of Identifying Changed Product:**

The die part number (PN) is marked on all Microsemi products affected by this change. A letter will be added to the die PN to indicate the foundry by which the chip was built.

### **Products Affected by this Change:**

MSC part number	Description	Package
MSC010SDA120B	Schottky Diode, 1200V, 10A, RoHS	TO-247
MSC010SDA120K	Schottky Diode, 1200V, 10A, RoHS	TO-220
MSC020SDA120B	Schottky Diode, 1200V, 20A, RoHS	TO-247
MSC030SDA120B	Schottky Diode, 1200V, 30A, RoHS	TO-247
MSC030SDA120K	Schottky Diode, 1200V, 30A, RoHS	TO-220
MSC050SDA120B	Schottky Diode, 1200V, 50A, RoHS	TO-247
MSC050SDA120K	Schottky Diode, 1200V, 50A, RoHS	TO-220

## **Production Shipment Schedule:**

There will be a transition period during which product from either wafer fab may be shipped while any inventory from the current Bend wafer fab is depleted.

Any orders for products required to be built in the current Bend wafer fab should be placed by December 31, 2017 and are required to ship by September 30, 2018.

#### **Qualification Data:**

Qualification data is not available at this time but will be made available as we achieve qualification at the foundry.

# Sample availability:

Samples of the product from the 6" foundry will be made available as soon as possible with an estimated date of early 2018 for samples and qualified production units in mid-2018. Please contact your local Microsemi representative to place sample orders.

#### **Contact Information:**

Microsemi Corporation Discrete Products Group Power Discretes & Modules Business Unit

http://www.microsemi.com/salescontacts

Email: PCN\_Action@microsemi.com

Regards,

Microsemi Corporation



Microsemi Corporate Headquarters One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 E-mail: sales.support@microsemi.com

www.microsemi.com

©2016 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other respective owners.

Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi does not grant, explicitly, to any party any patent rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document is proprietary to Microsemi, and Microsemi reserves the right to make any changes to the information in this document or to any products and services at any time without

#### About Microsemi

Microsemi Corporation (Nasdag: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions; security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as trademarks and service marks are the property of their well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif., and has approximately 4,800 employees globally. Learn more at www.microsemi.com.



Any projected dates in this PCN are based on the most current product information at the time this PCN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

This Product/Process Change Notification is confidential and proprietary information of Microsemi and is intended only for distribution by Microsemi to its customers, for customers' use only. It must not be copied or provided to any third party without Microsemi's prior written consent.

<To be attached only where customer acknowledgement/approval is necessary prior to implementation>

### CHANGE APPROVAL SUPPLEMENT

# **Customer Acknowledgement / Approval for**

Product/Process Change Notification No: PPS110A060B14

Microsemi Corporation intends to implement this change 90 days after this notification. Acknowledgement of your company's acceptance of this change is requested per contractual agreement. Response within 30 days is required.

Accepted	Rejected	
Signature	Date	
Name	Title	
Please enter rationale for r	ejection, if applicable:	



Microsemi Corporate Headquarters One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 E-mail: sales.support@microsemi.com

www.microsemi.com

©2016 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other respective owners.

Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document is proprietary to Microsemi, and Microsemi reserves the right to make any changes to the information in this document or to any products and services at any time without

#### About Microsemi

Microsemi Corporation (Nasdag: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions; security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as trademarks and service marks are the property of their well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif., and has approximately 4,800 employees globally. Learn more at www.microsemi.com.